



TruPulse nano 20 to 300 W Nanosecond-pulsed fiber lasers

Product selection parameters									
Wavelength	nm								
Beam quality options				S type					
Beam quality	M ²			< 1.3					
Rated average power	W	20		30	50	100		20	30
PulseTune functionality	+	HS	EP	F	HS	EP	RM	EP	RM
Beam delivery cable length	m			2			2/3		
Beam delivery optic/connector		ILOC / ILLK		ILLK					ILOC / ILLK
Pulse parameters									
Max. peak power*	kW			> 7					
Max. pulse energy	mJ	> 0.6	> 0.8	> 0.6		>	> 1		> 1
Pulse repetition frequency range	kHz	1-1000	1-4000	1-1	1000	1-4000	1-500	1-4000	1-500
Pulse duration range	ns	10-240	3-2000	10-240	11-220	4-2000	26-250	3-2000	26-250
PulseTune waveforms		24	48	2	24	47	2	48	2
CW mode			Y	'es		N.	No	Yes	No
Modulation range in CW mode	kHz	1–100			N	I/A	N/A		
Output power stability (peak-to-peak)*	%								< 5
Cooling options									
Air-cooled or water-cooled									Air
Environmental									
Ambient temperature range	°C		0-45		0-42	5-40		0-45	
Relative humidity range									

^{*} Measured at rated average power, waveform 0, max. pulse energy and over full operating temperature range. Models with longer beam delivery cables may have lower per

Beam quality options

S type – single mode ($M^2 < 1.3$)

Generating very fine spot size < 20 μ m with high power stability and large depth of focus. Ideally suited to applications requiring small feature sizes.

Z type – general purpose ($M^2 < 1.6$)

Offering higher peak power and pulse energy with only minor increase in spot size and good depth of focus.

L type – low mode (M² 1.6–2.0)

General marking applications giving slightly larger spots and features that are more appropriate to making marks visible to the naked eye.

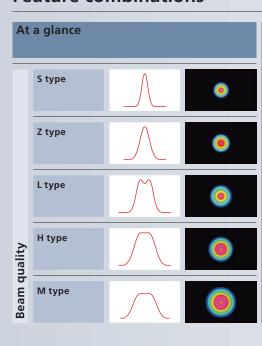
H type – high mode (M² 2.5 – 3.5)

Offering higher pulse energies, peak powers and even larger spots ideal for wide lines, filled font type applications and large area coverage.

M type – multimode (M² 4.0–6.0)

Highest pulse energies and longer pulse durations ideal for welding and cleaning.

Feature combinations





		1060										
Z type						L type H typ		ype	M type			
<1.6					-	1.8 3		3	5			
5	0	7	0	100	130	200	300	20		40	70	200
	EP	RM			EP			HS	EP	HS		EP
3	3		3.	/5		3		2/3	2	3/5		3/8
				ILOC+		IBeam		ILOC / ILLK	ILLK	ILOC	ILOC / ILLK	
		> 10						>	12	>	20	> 50
	> 1.2	> 1	>1.2	> 1.3	> 1.3 > 1.5			> 0.8	> 1	> 1.25		> 5
	1-4000	1-500			1–4000				1–1	000	1-4000	
	3-2000	28-260	3-2000	4-2000	3-2000	9-2000	10-1200	10-220	2-500	10-240	10-250	12-2000
	48	2	4	8	47	45	41	25	40	24		45
	Yes	No	Y	es	N	lo	Yes		Υ	es	No	
	1-100	N/A	1-	100	N/A 1–100				1-	1–100		
						< 8		<				
							Water			Air		
0-40 5-40 10-45 10-40				10-40	15-37		0-45		0-40	10-40		
	5-95%	RH (non-cod	ensing)									

ak power than stated.

PulseTune functionality (in W)

RM	HS	EP
	20, 30, 50	20, 100
20, 30, 50, 70		20, 50, 70, 100, 130, 200, 300
	20	20
	40, 70	
		200

PulseTune functionality

Gives users greater control of pulse conditions providing increased pulse energy, peak power and pulse repetition frequency.



RM Series (reduced mode)

- Models benefit from 2 PulseTune waveforms
- Up to 0.5 MHz pulse repetition frequency





HS Series (high specification)

- Up to 25 PulseTune waveforms
- Up to 1 MHz pulse repetition frequency





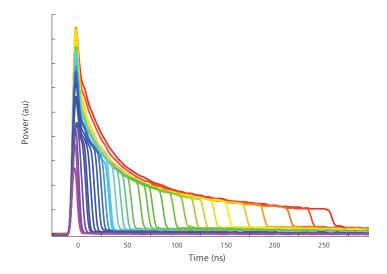
EP Series (extended performance)

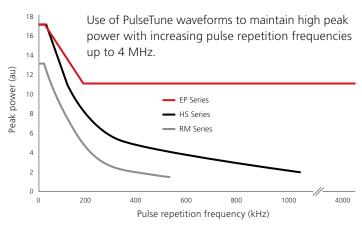
- Up to 48 optimised PulseTune waveforms
- Up to 4 MHz pulse repetition frequency



PulseTune technology

Our PulseTune technology provides the ability to select waveforms, offering pulse durations from 3 to 2,000 ns. Each pulse waveform is designed for maximum peak power and pulse energy at an optimised pulse repetition frequency.











TruPulse nano and GTWave® are registered trademarks of TRUMPF Laser UK Ltd

Terms and conditions

All product information is believed to be accurate and subject to change without notice. A complete product specification will be issued on request and also at time of order acknowledgement. The user assumes all risks and liability whatsoever in connection with the use of the product and its application. These lasers are designed as products for incorporation or integration into other equipment.

Key applications

Product range by bea	am quality	S type	Z type	L type	H type	M type
Ablation	大吉 大吉 · · · · · · · · · · · · · · · · ·	•	•			
Cleaning					•	-
Drilling						
Engraving, deep						-
Engraving, fine	With thanks on all your f	•				
Marking anodised and painted materials	2050 2050 2050 2050 2050					-
Marking, general				•		
Marking, metal				•		
Marking, plastic (night and day)	STOP FIGNS	•		•		
Micro-machining		•				
Precision cutting		•				
Scribing	**************************************					
Solar cell processing		•				
Thin film patterning		•	•		•	
Thin foil cutting		•	•		•	
Welding	3				•	-

